412TW-PA-20154

# SINGLE STEP BONDING OF THICK ANODIZED ALUMINUM OXIDE TEMPLATES TO SILICON WAFERS FOR ENHANCED SYSTEM-ON-A-CHIP PERFORMANCE

4
1
2
T
W


GIBSON SCISCO
KATHERINE HAYNES
KEVIN JONES
KIRK ZIEGLER

AIR FORCE TEST CENTER
EDWARDS AFB, CA



Approved for public release; distribution is unlimited.
412TW-PA-20154



412TH TEST WING
EDWARDS AIR FORCE BASE, CALIFORNIA
AIR FORCE MATERIEL COMMAND
UNITED STATES AIR FORCE